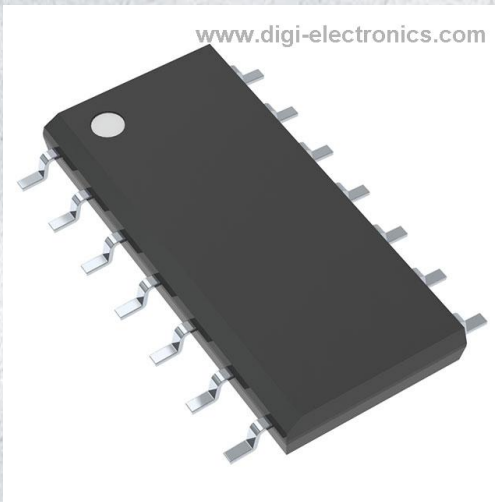


74VCX00MX Datasheet



<https://www.DiGi-Electronics.com>

DiGi Electronics Part Number	74VCX00MX-DG
Manufacturer	onsemi
Manufacturer Product Number	74VCX00MX
Description	IC GATE NAND 4CH 2-INP 14SOIC
Detailed Description	NAND Gate IC 4 Channel 14-SOIC



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.

Purchase and inquiry

Manufacturer Product Number:

74VCX00MX

Series:

74VCX

Logic Type:

NAND Gate

Number of Inputs:

2

Voltage - Supply:

1.2V ~ 3.6V

Current - Output High, Low:

24mA, 24mA

Input Logic Level - High:

1.6V ~ 2V

Operating Temperature:

-40°C ~ 85°C

Supplier Device Package:

14-SOIC

Base Product Number:

74VCX00

Manufacturer:

onsemi

Product Status:

Obsolete

Number of Circuits:

4

Features:

-

Current - Quiescent (Max):

20 μ A

Input Logic Level - Low:

0.7V ~ 0.8V

Max Propagation Delay @ V, Max CL:

2.8ns @ 3.3V, 30pF

Mounting Type:

Surface Mount

Package / Case:

14-SOIC (0.154", 3.90mm Width)

Environmental & Export classification

RoHS Status:

ROHS3 Compliant

REACH Status:

REACH Unaffected

HTSUS:

8542.39.0001

Moisture Sensitivity Level (MSL):

1 (Unlimited)

ECCN:

EAR99



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December 2013

74VCX00

Low Voltage Quad 2-Input NAND Gate with 3.6V Tolerant Inputs and Outputs

Features

- 1.2V to 3.6V V_{CC} supply operation
- 3.6V tolerant inputs and outputs
- t_{PD}
 - 2.8ns max. for 3.0V to 3.6V V_{CC}
- Power-off high impedance inputs and outputs
- Static Drive (I_{OH}/I_{OL})
 - $\pm 24mA$ @ 3.0V V_{CC}
- Uses proprietary noise/EMI reduction circuitry
- Latchup performance exceeds JEDEC 78 conditions
- ESD performance:
 - Human body model > 2000V
 - Machine model > 250V
- Leadless DQFN package

General Description

The VCX00 contains four 2-input NAND gates. This product is designed for low voltage (1.2V to 3.6V) V_{CC} applications with I/O compatibility up to 3.6V.

The VCX00 is fabricated with an advanced CMOS technology to achieve high speed operation while maintaining low CMOS power dissipation.


Ordering Information

Order Number	Package Number	Package Description
74VCX00M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
74VCX00BQX ⁽¹⁾	MLH14A	14-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JEDEC MO-241, 2.5 x 3.0mm
74VCX00MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Note:

1. DQFN package available in Tape and Reel only.

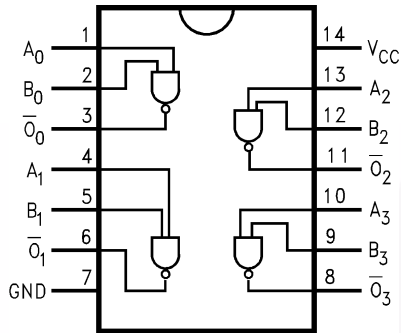
Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

 All packages are lead free per JEDEC: J-STD-020B standard.

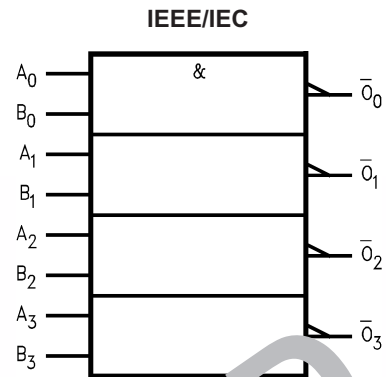
74VCX00 — Low Voltage Quad 2-Input NAND Gate with 3.6V Tolerant Inputs and Outputs

Connection Diagrams

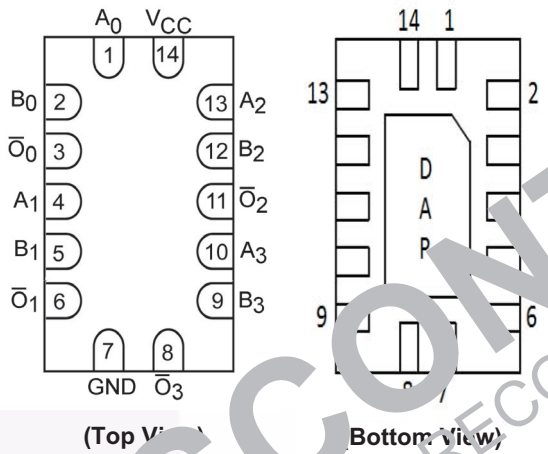
Pin Assignments for SOIC and TSSOP



Logic Symbol



Pad Assignments for DQFN



Pin Description

Pin Name	Description
B_n	Inputs
\bar{O}_n	Outputs
DAP	No Connect

Note: DAP (Die Attach Pad)

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V_{CC}	Supply Voltage	-0.5V to +4.6V
V_I	DC Input Voltage	-0.5V to 4.6V
V_O	DC Output Voltage HIGH or LOW State ⁽²⁾	-0.5V to $V_{CC} + 0.5V$
	$V_{CC} = 0V$	-0.5V to 4.6V
I_{IK}	DC Input Diode Current, $V_I < 0V$	-50mA
I_{OK}	DC Output Diode Current $V_O < 0V$	-50mA
	$V_O > V_{CC}$	+50mA
I_{OH} / I_{OL}	DC Output Source/Sink Current	±50mA
I_{CC} or GND	DC V_{CC} or Ground Current per Supply Pin	±100mA
T_{STG}	Storage Temperature Range	-65°C to +150°C

Note:

2. I_O Absolute Maximum Rating must be observed.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Rating
V_{CC}	Supply Operating Voltage	1.2V to 3.6V
V_I	Input Voltage	-0.3V to 3.6V
V_O	Output Voltage, HIGH or LOW State	0V to V_{CC}
I_O / I_C	Output Current $V_{CC} = 3.0V$ to 3.6V	±24mA
	$V_{CC} = 2.3V$ to 2.7V	±18mA
	$V_{CC} = 1.65V$ to 2.3V	±6mA
	$V_{CC} = 1.4V$ to 1.6V	±2mA
	$V_{CC} = 1.2V$	±100μA
T_A	Free Air Operating Temperature	-40°C to +85°C
$\Delta t / \Delta V$	Minimum Input Edge Rate, $V_{IN} = 0.8V$ to 2.0V, $V_{CC} = 3.0V$	10ns/V

Note:

3. Floating or unused inputs must be held HIGH or LOW

DC Electrical Characteristics

Symbol	Parameter	V _{CC} (V)	Conditions	Min	Max	Units			
V _{IH}	HIGH Level Input Voltage	2.7–3.6		2.0		V			
		2.3–2.7		1.6					
		1.65–2.3		0.65 × V _{CC}					
		1.4–1.6		0.65 × V _{CC}					
		1.2		0.65 × V _{CC}					
V _{IL}	LOW Level Input Voltage	2.7–3.6			0.8	V			
		2.3–2.7			0.7				
		1.65–2.3			0.35 × V _{CC}				
		1.4–1.6			0.35 × V _{CC}				
		1.2			0.05 × V _{CC}				
V _{OH}	HIGH Level Output Voltage	2.7–3.6	I _{OH} = –100μA	V _{CC} – 0.2		V			
		2.7	I _{OH} = –12mA	2					
		3.0	I _{OH} = –18mA	2					
		3.0	I _{OH} = –24mA	2.2					
		2.3–2.7	I _{OH} = –100μA	V _{CC} – 0.2					
		2.3	I _{OH} = 6mA	2.0					
		2.3	I _{OH} = –12mA	1.8					
		2.3	I _{OH} = –18mA	1.7					
		2.3–2.7	I _{OH} = –100μA	V _{CC} – 0.2					
		1.65–2.3	I _{OH} = –6mA	1.25					
		1.4–1.6	I _{OH} = –100μA	V _{CC} – 0.2					
		1.4	I _{OH} = –2mA	1.05					
		1.2	I _{OH} = –100μA	V _{CC} – 0.2					
		V _{OL}	LOW Level Output Voltage	2.7–3.6	I _{OL} = 100μA			0.2	V
2.7	I _{OL} = 12mA				0.4				
3.0	I _{OL} = 18mA				0.4				
3.0	I _{OL} = 24mA				0.55				
2.3–2.7	I _{OL} = 100μA				0.2				
2.3	I _{OL} = 12mA				0.4				
2.3	I _{OL} = 18mA				0.6				
1.65–2.3	I _{OL} = 100μA				0.2				
1.65	I _{OL} = 6mA				0.3				
1.4–1.6	I _{OL} = 100μA				0.2				
1.4	I _{OL} = 2mA				0.35				
1.2	I _{OL} = 100μA				0.05				
I _I	Input Leakage Current			1.4–3.6	0 ≤ V _I ≤ 3.6V		±5.0	μA	
I _{OZ}	3-STATE Output Leakage			1.4–3.6	0 ≤ V _O ≤ 3.6V, V _I = V _{IH} or V _{IL}		±10	μA	
I _{OFF}	Power-OFF Leakage Current	0	0 ≤ (V _I , V _O) ≤ 3.6V		10	μA			
I _{CC}	Quiescent Supply Current	1.4–3.6	V _I = V _{CC} or GND		20	μA			
			V _{CC} ≤ (V _I , V _O) ≤ 3.6V ⁽⁴⁾		±20				
ΔI _{CC}	Increase in I _{CC} per Input	2.7–3.6	V _{IH} = V _{CC} – 0.6V		750	μA			

Note:

4. Outputs disabled or 3-STATE only.

AC Electrical Characteristics⁽⁵⁾

Symbol	Parameter	V _{CC} (V)	Conditions	T _A = -40°C to +85°C		Units	Figure Number
				Min.	Max.		
t _{PHL} , t _{PLH}	Propagation Delay	3.3 ± 0.3	C _L = 30pF, R _L = 500Ω	0.6	2.8	ns	Fig. 1 Fig. 2
		2.5 ± 0.2		0.8	3.7		
		1.8 ± 0.15		1.0	7.4		
		1.5 ± 0.1	C _L = 15pF, R _L = 2kΩ	1.0	14.8		Fig. 3 Fig. 4
		1.2		1.5	37.0		
t _{OSSL} , t _{OSLH}	Output to Output Skew ⁽⁶⁾	3.3 ± 0.3	C _L = 30pF, R _L = 500Ω		0.5		
		2.5 ± 0.2			0.5		
		1.8 ± 0.15			0.75		
		1.5 ± 0.1	C _L = 15pF, R _L = 2kΩ		1.5		
		1.2			5		

Note:

- For C_L = 50pF, add approximately 300ps to the AC Maximum specification.
- Skew is defined as the absolute value of the difference between the output propagation delay for any two separate outputs of the same device. The specification applies to any output switching in the same direction, either HIGH-to-LOW (t_{OSSL}) or LOW-to-HIGH (t_{OSLH}).

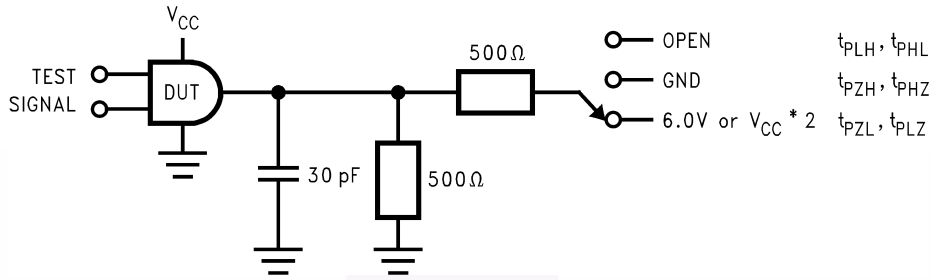
Dynamic Switching Characteristics

Symbol	Parameter	V _{CC} (V)	Conditions	T _A = 25°C	Unit
				Typical	
V _{OLP}	Quiet Output Dynamic Peak V _{OL}	1.8	C _L = 30pF, V _{IH} = V _{CC} , V _{IL} = 0V	0.25	V
		2.5		0.6	
		3.3		0.8	
V _{OLV}	Quiet Output Dynamic Valley V _{OL}	1.8	C _L = 30pF, V _{IH} = V _{CC} , V _{IL} = 0V	-0.25	V
		2.5		-0.6	
		3.3		-0.8	
V _{OHV}	Quiet Output Dynamic Valley V _{OH}	1.8	C _L = 30pF, V _{IH} = V _{CC} , V _{IL} = 0V	1.5	V
		2.5		1.9	
		3.3		2.2	

Capacitance

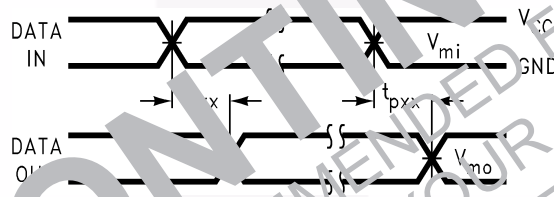
Symbol	Parameter	Conditions	T _A = +25°C	Units
			Typical	
C _{IN}	Input Capacitance	V _I = 0V or V _{CC} , V _{CC} = 1.8V, 2.5V or 3.3V	6	pF
C _{OUT}	Output Capacitance	V _I = 0V or V _{CC} , V _{CC} = 1.8V, 2.5V or 3.3V	7	pF
C _{PD}	Power Dissipation Capacitance	V _I = 0V or V _{CC} , f = 10 MHz, V _{CC} = 1.8V, 2.5V or 3.3V	20	pF

AC Loading and Waveforms (V_{CC} 3.3V \pm 0.3V to 1.8V \pm 0.15V)



Test	Switch
t_{PLH}, t_{PHL}	Open

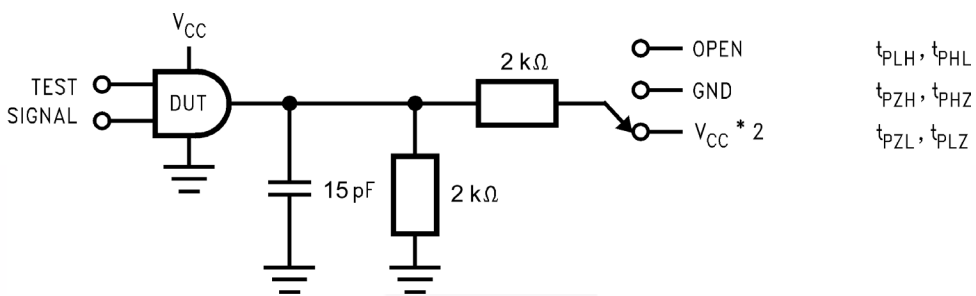
Figure 1. AC Test Circuit



	V_{CC}		
Symbol	3.3V \pm 0.3V	2.5V \pm 0.2V	1.8V \pm 0.15V
V_{mi}	1.5V	$V_{CC} / 2$	$V_{CC} / 2$
V_{mo}	1.5V	$V_{CC} / 2$	$V_{CC} / 2$

Figure 2. Waveform for Inverting and Non-inverting Functions

AC Loading and Waveforms ($V_{CC} 1.5 \pm 0.1V$ to $1.2V$)



Test	SWITCH
t_{PLH}, t_{PHL}	Open
t_{PZL}, t_{PLZ}	$V_{CC} \times 2$ at $V_{CC} = 1.5V \pm 0.1V$
t_{PZH}, t_{PHZ}	GND

Figure 3. AC Test Circuit



Symbol	V_{CC}
	$1.5V \pm 0.1V$
V_{mi}	$V_{CC} / 2$
V_{mo}	$V_{CC} / 2$

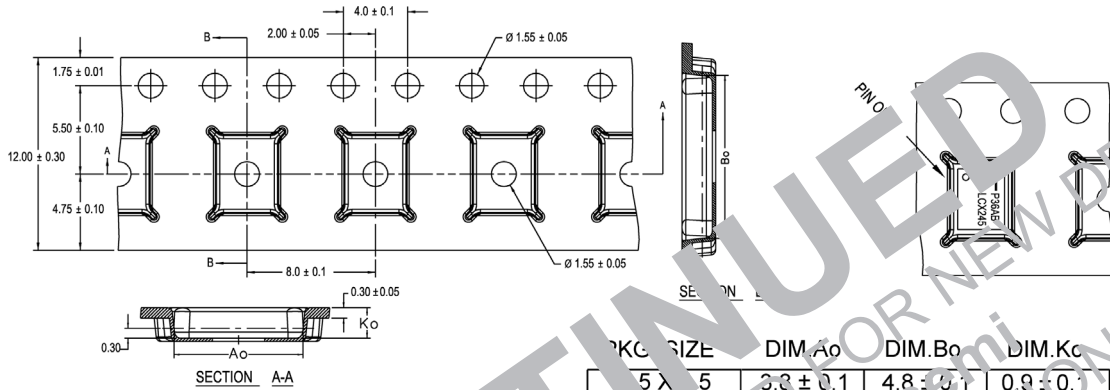
Figure 4. Waveform for Inverting and Non-Inverting Functions

Tape and Reel Specification

Tape Format for DQFN

Package Designator	Tape Section	Number of Cavities	Cavity Status	Cover Tape Status
BQX	Leader (Start End)	125 (Typ.)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (Typ.)	Empty	Sealed

Tape Dimensions inches (millimeters)



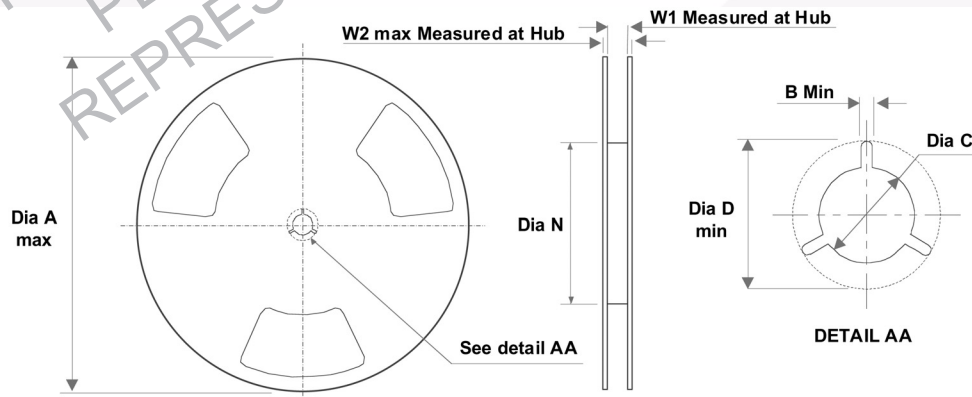
PACKAGE SIZE	DIM.Ao	DIM.Bo	DIM.Ko
5 X 5	3.3 ± 0.1	4.8 ± 0.1	0.9 ± 0.1
5 X 3.0	3.3 ± 0.1	3.5 ± 0.1	0.9 ± 0.1
2.5 X 4.5	2.8 ± 0.1	4.8 ± 0.1	0.9 ± 0.1
2.5 X 3.5	2.8 ± 0.1	3.8 ± 0.1	0.9 ± 0.1
2.5 X 3.0	2.8 ± 0.1	3.3 ± 0.1	0.9 ± 0.1
2.5 X 2.5	2.3 ± 0.1	2.8 ± 0.1	0.9 ± 0.1

DIMENSIONS ARE IN MILLIMETERS

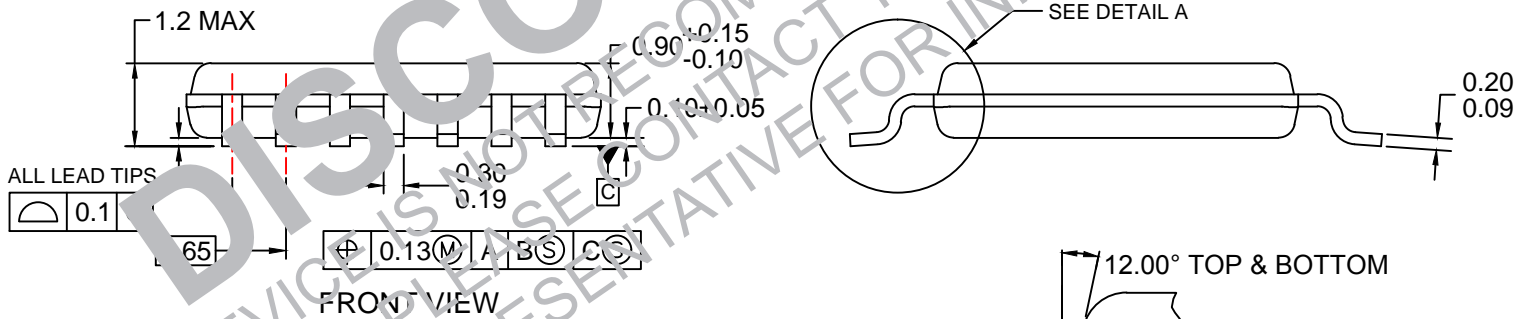
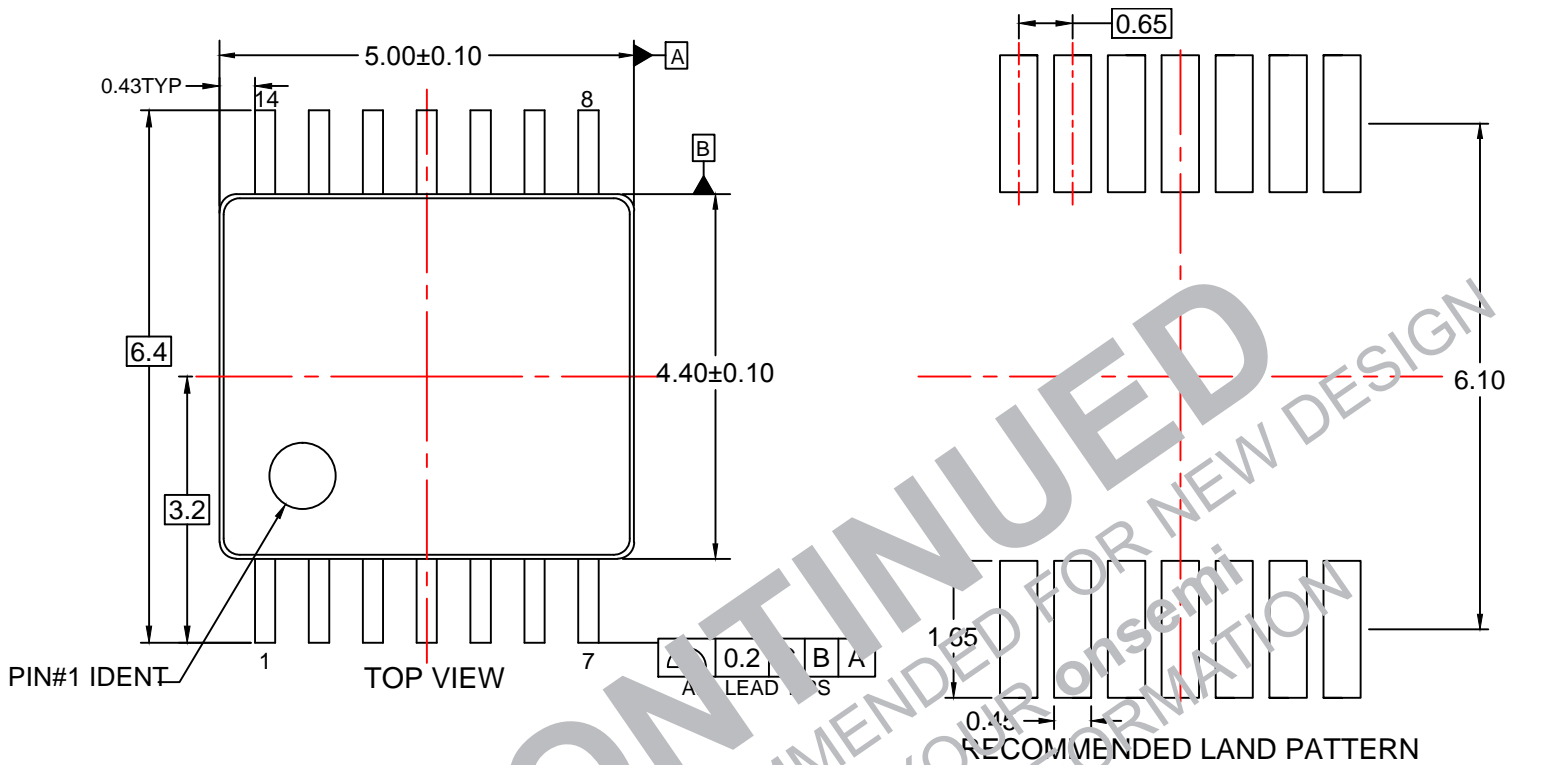
NOTES: unless otherwise specified:

1. Cumulative pitch error for feeding holes and cavities (chip pockets) not to exceed 0.004 [0.20] over 10 pitch span.
 2. Smallest allowable bending radius.
 3. Thru hole inside cavity is centered within cavity.
 4. Tolerance is ±0.002 [0.05] for these dimensions on all 12mm tapes.
 5. Lead length measured on a plane 0.120 [0.30] above the bottom of the pocket.
 6. K_o measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
- Pocket position relative to sprocket hole measured as true position of pocket. Not pocket hole.
 All containing dimension is millimeter. Dimension in inches rounded.

Reel Dimensions inches (millimeters)



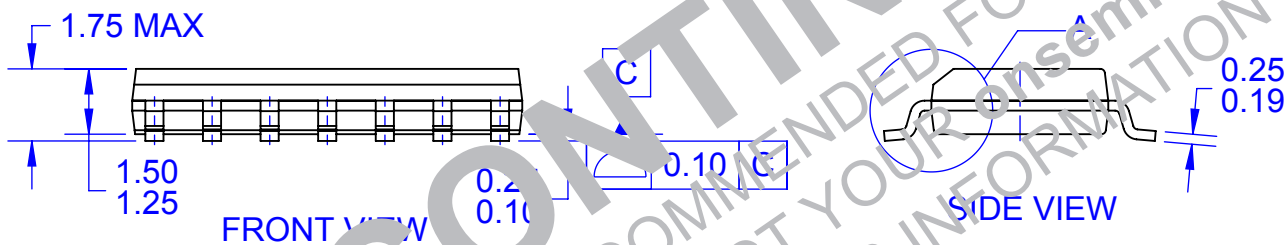
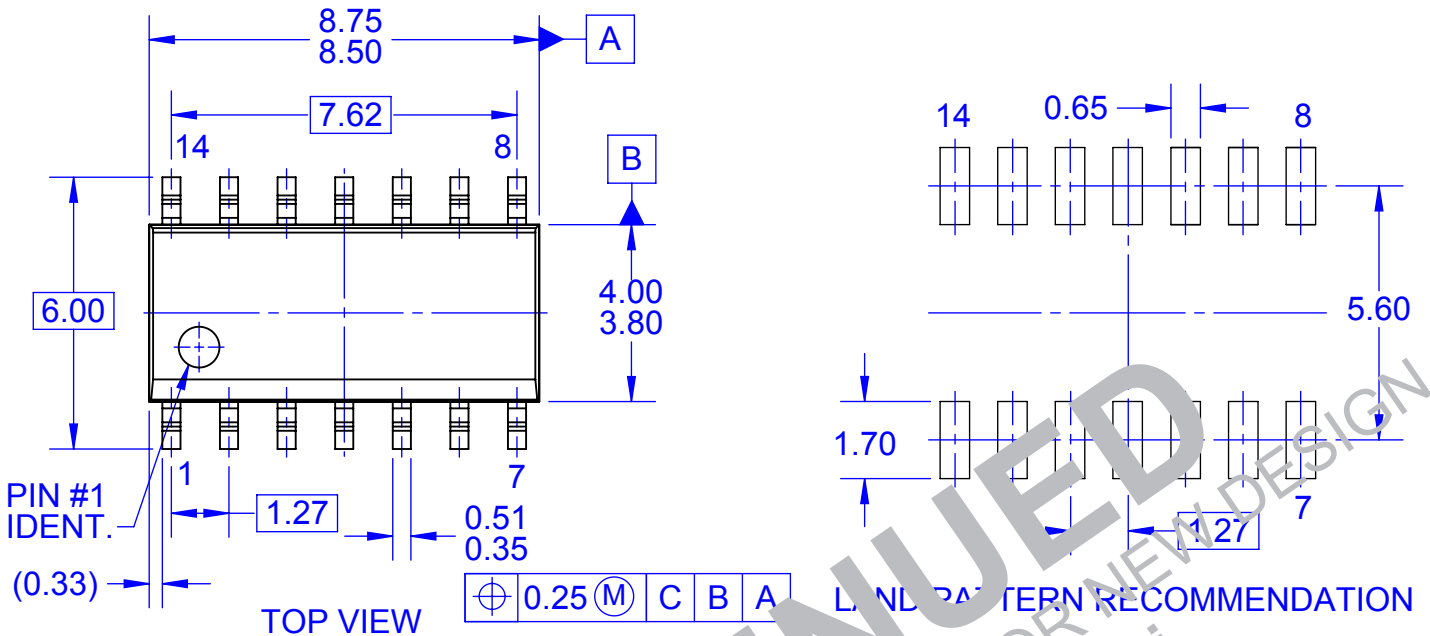
Tape Size	A	B	C	D	N	W1	W2
12mm	13.0 (330.0)	0.059 (1.50)	0.512 (13.00)	0.795 (20.20)	2.165 (55.00)	0.488 (12.4)	0.724 (18.4)



NOTES:

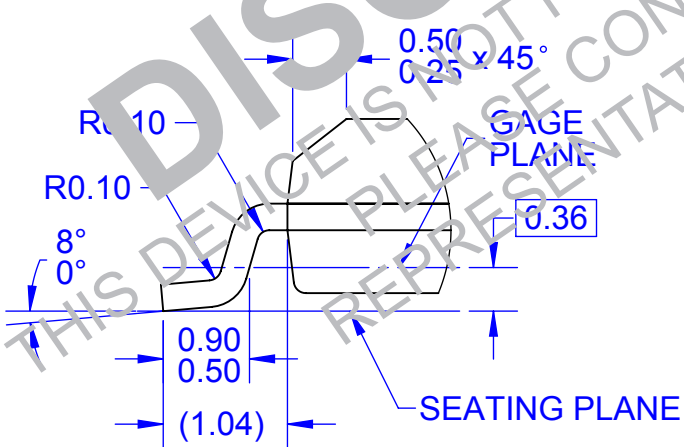
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- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS
- D. DIMENSIONING AND TOLERANCES PER ANSI Y14.5M, 2009.
- E. LANDPATTERN STANDARD: SOP65P640X110-14M.
- F. DRAWING FILE NAME: MKT-MTC14rev7.

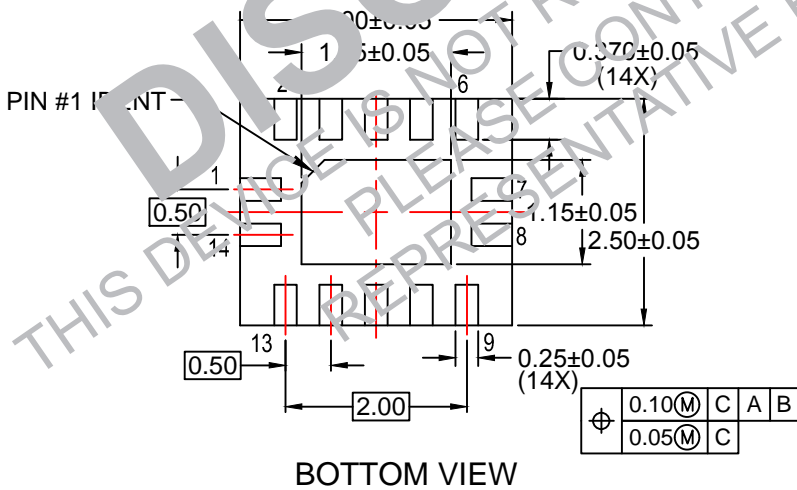
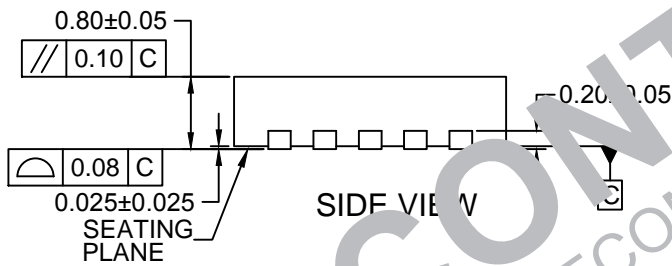
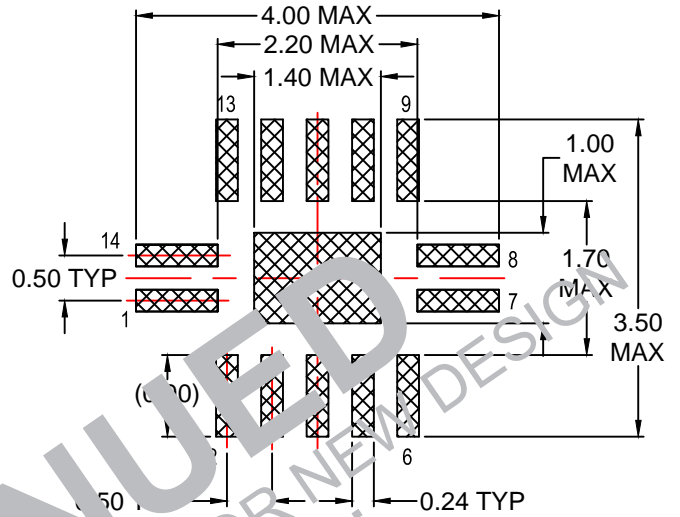
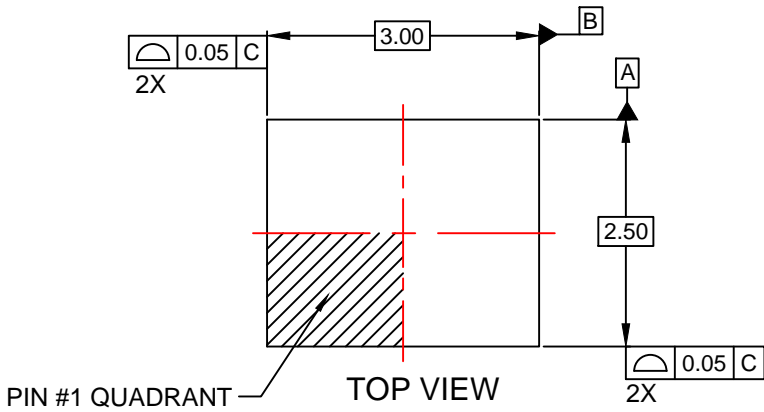




NOTES:

- A. CONFORMS TO JEDEC MS-012, VARIATION AB, ISSUE C
- B. ALL DIMENSIONS ARE IN MILLIMETERS
- C. DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS
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- E. CONFORMS TO ASME Y14.5M, 2009
- D. DRAWING FILENAME: MKT-M14Arev14






NOTES:

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- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.
- E. DRAWING FILENAME: MKT-MLP14Arev2.



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